The SN54LS07 and SN74LS17 are obsolete and are no longer supplied.

SN54LS07, SN74LS07, SN74LS17 HEX BUFFERS/DRIVERS WITH OPEN-COLLECTOR HIGH-VOLTAGE OUTPUTS

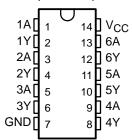
SDLS021B - MAY 1990 - REVISED JANUARY 2002

- Convert TTL Voltage Levels to MOS Levels
- High Sink-Current Capability
- Input Clamping Diodes Simplify System Design
- Open-Collector Driver for Indicator Lamps and Relays

description

These hex buffers/drivers feature high-voltage open-collector outputs to interface with high-level circuits or for driving high-current loads. They are also characterized for use as buffers for driving TTL inputs. The 'LS07 devices have a rated output voltage of 30 V, and the SN74LS17 has a rated output voltage of 15 V. The maximum sink current is 30 mA for the SN54LS07 and 40 mA for the SN74LS07 and SN74LS17.

SN54LS07 . . . J PACKAGE SN74LS07, SN74LS17 . . . D, DB, N, OR NS PACKAGE (TOP VIEW)



These circuits are compatible with most TTL families. Inputs are diode-clamped to minimize transmission-line effects, which simplifies design. Typical power dissipation is 140 mW and average propagation delay time is 12 ns

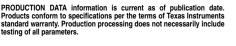
ORDERING INFORMATION

TA	PACKAGE [†]		AGET ORDERABLE PART NUMBER	
0°C to 70°C	SOIC - D	Tube	SN74LS07D	LS07
	3010 - 0	Tape and reel	SN74LS07DR	L307
	SOIC - DB	Tape and reel	SN74LS07DBR	LS07
	SOP - NS	Tape and reel	SN74LS07NSR	74LS07
	PDIP – N Tube		SN74LS07N	SN74LS07N

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

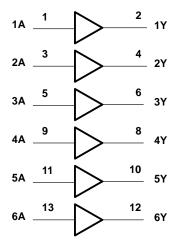


Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

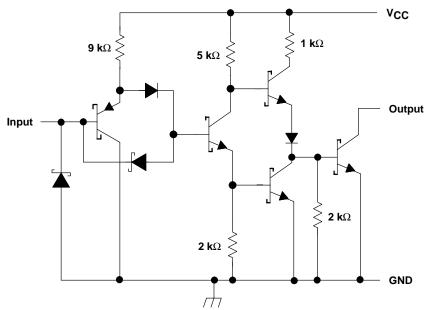




logic diagram (positive logic)



schematic (each gate)



Resistor values shown are nominal.



SN54LS07, SN74LS07, SN74LS17 HEX BUFFERS/DRIVERS WITH OPEN-COLLECTOR HIGH-VOLTAGE OUTPUTS

SDLS021B - MAY 1990 - REVISED JANUARY 2002

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V _{CC}		7 V
Input voltage, V _I (see Note 1)		
Output voltage, VO (see Notes 1 and 2): S		
S	SN74LS17	15 V
Package thermal impedance, θ _{JA} (see Note	86°C/W	
		96°C/W
	N package	80°C/W
	NS package	76°C/W
Storage temperature range, T _{stg}		-65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values are with respect to GND.

- 2. This is the maximum voltage that should be applied to any output when it is in the off state.
- 3. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions

				SN54LS07		SN74LS07 SN74LS17			UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	
Vcc	Supply voltage		4.5	5	5.5	4.75	5	5.25	V
VIH	/IH High-level input voltage		2			2			V
V _{IL}	Low-level input voltage				0.8			0.8	V
VOH High-level output voltage	High lovel output veltage	'LS07			30			30	V
	High-level output voltage	SN74LS17						15	V
loL	I _{OL} Low-level output current				30			40	mA
TA	A Operating free-air temperature		-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS [‡]			SN54	SN54LS07		SN74LS07 SN74LS17		
				MIN	MAX	MIN	MAX		
VIK	$V_{CC} = MIN,$	$I_{I} = -12 \text{ mA}$			-1.5		-1.5	٧	
ЮН	V _{CC} = MIN,	V _{IH} = 2 V	'LS07, V _{OH} = 30 V		0.25		0.25	mA	
			SN74LS17, V _{OH} = 15 V				0.25	IIIA	
VOL	V _{CC} = MIN,	V _{IL} = 0.8 V	I _{OL} = 16 mA		0.4		0.4	, , , , , , , , , , , , , , , , , , ,	
			I _{OL} = MAX§		0.7		0.7	V	
lį	$V_{CC} = MAX$,	V _I = 7 V	-		1		1	mA	
lіН	$V_{CC} = MAX$,	V _I = 2.4 V			20		20	μΑ	
Ι _{ΙL}	$V_{CC} = MAX$,	V _I = 0.4 V			-0.2		-0.2	mA	
Іссн	$V_{CC} = MAX$				14		14	mA	
ICCL	$V_{CC} = MAX$				45		45	mA	

[‡] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



 $I_{OL} = 30$ mA for SN54 series parts and 40 mA for SN74 series parts.

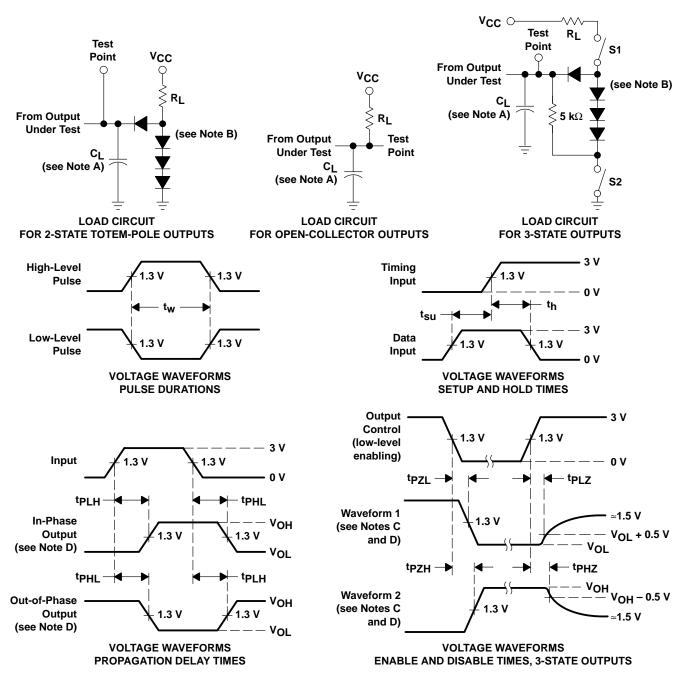
SN54LS07, SN74LS07, SN74LS17 HEX BUFFERS/DRIVERS WITH OPEN-COLLECTOR HIGH-VOLTAGE OUTPUTS SDLS021B - MAY 1990 - REVISED JANUARY 2002

The SN54LS07 and SN74LS17 are obsolete and are no longer supplied.

switching characteristics, V_{CC} = 5 V, T_A = 25°C (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS		MIN	TYP	MAX	UNIT
t _{PLH}	А	Y	$R_L = 110 \Omega$, $C_L = 15 pF$	C: _ 15 pE		6	10	
t _{PHL}					19	30	ns	

PARAMETER MEASUREMENT INFORMATION



- NOTES: A. C_L includes probe and jig capacitance.
 - B. All diodes are 1N3064 or equivalent.
 - C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - D. S1 and S2 are closed for tpLH, tpHZ, and tpLZ; S1 is open and S2 is closed for tpZH; S1 is closed and S2 is open for tpZL.
 - E. Phase relationships between inputs and outputs have been chosen arbitrarily for these examples.
 - F. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O \approx 50 \ \Omega$, $t_f \leq$ 1.5 ns, $t_f \leq$ 2.6 ns.
 - G. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms



IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third—party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Mailing Address:

Texas Instruments
Post Office Box 655303
Dallas, Texas 75265

Copyright © 2001, Texas Instruments Incorporated